

PRECISION MICROPOWER SHUNT VOLTAGE REFERENCE

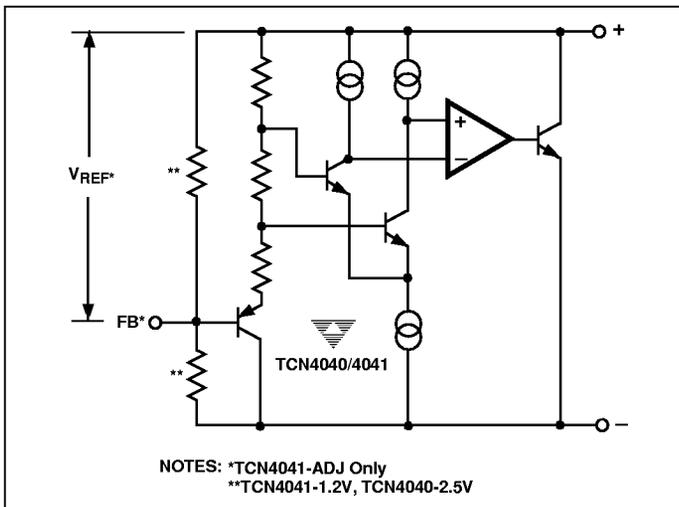
FEATURES

- Small Packages ... SOT-23B-3, TO-92, and SOIC-8
- Output Capacitor Not Required
- Handles Capacitive Loads
- Adjustable Voltage and Fixed Reverse Breakdown Voltage:
 - TCN40402.5V
 - TCN4041 1.2V, Adjustable
- Low Output Noise
- Wide Operating Current Range:
 - TCN4040 60 μ A to 15 mA
 - TCN4041 60 μ A to 12 mA
- Extended Operating Temperature Range - 40°C to + 85°C

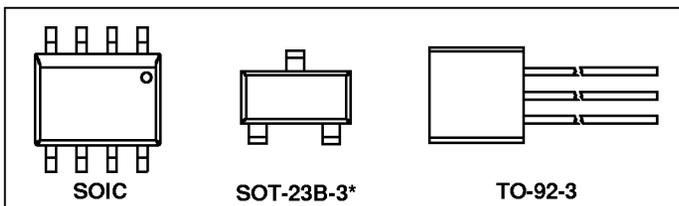
APPLICATIONS

- Portable, Battery-Powered Equipment
- Data Acquisition Systems
- Instrumentation
- Process Control
- Energy Management
- Product Testing
- Automotive
- Precision Audio Components

FUNCTIONAL BLOCK DIAGRAM



AVAILABLE PACKAGES



GENERAL DESCRIPTION

For applications in tight quarters, the TCN4040/4041 precision voltage references are available in space-saving 3 mm by 1.3 mm SOT-23B-3 surface mount packages. The devices eliminate the need for an external stabilizing capacitor while maintaining stability with any capacitive load.

The minimum operating current for both the TCN4041-1.2V and the TCN4041-ADJ is 60 μ A. Both versions have a maximum operating current of 12 mA. Minimum operating current for the TCN4040 also is 60 μ A, and maximum operating current is 15 mA.

Low dynamic impedance maintains stable reverse breakdown voltage accuracy over a wide range of operating temperatures and currents.

The TCN4040/4041 are available in small SOT-23B-3, TO-92, and 8-Pin SOIC packages.

ORDERING INFORMATION

PART CODE **TC404X** **X** **XXX** **E** **XX** **XXX**

Product Part Number: _____
4040
4041

Voltage Tolerance Temperature Coefficient Grade: _____
C: \pm 0.5%, 100 ppm/ $^{\circ}$ C Max
D: \pm 1.0%, 150 ppm/ $^{\circ}$ C Max
E: \pm 2.0%, 150 ppm/ $^{\circ}$ C Max

Grade Output Voltage: _____
1.2V: TCN4041C/D/E
2.5V: TCN4040C/D/E, TCN4041D
ADJ: TCN4041C/D

Operating Temperature Range: _____
E: - 40°C to +85°C

Package Type and Pin Count: _____
NB: SOT-23B-3*
OA: 8-Pin SOIC
ZB: TO-92-3

Taping Direction: _____
713: Standard Taping
723: Reverse Taping
No Suffix: TO-92 Bulk

*NOTE: *SOT-23B-3 is equivalent to the JEDEC (TO-236)

TCN4040
TCN4041

ABSOLUTE MAXIMUM RATINGS* (Note 1)

Reverse Current	20 mA
Forward Current	10 mA
Power Dissipation ($T_A = 25^\circ\text{C}$) (Note 2)	
8-Pin SOIC Package	470 mW
SOT-23B-3 Package	230 mW
TO-92 Package	440 mW
Storage Temperature	-65°C to $+150^\circ\text{C}$
Lead Temperature (Soldering, 10 seconds)	
8-Pin SOIC Package	$+260^\circ\text{C}$
SOT-23B-3 Package	$+300^\circ\text{C}$
TO-92 Package	$+300^\circ\text{C}$
ESD Susceptibility	
Human Body Model (Note 3)	2 kV
Machine Model (Note 3)	200V

OPERATING RATINGS (Notes 1 and 2)

Temperature Range	
($T_{\text{MIN}} \leq T_A \leq T_{\text{MAX}}$)	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$
Reverse Current	
TCN4040	60 μA to 15 mA
TCN4041-1.2	60 μA to 12 mA
TCN4041-ADJ	60 μA to 12 mA
Output Voltage Range	
TCN4041-ADJ	1.24V to 10V
Functional operation above the absolute maximum stress rating is not implied.	

- NOTES:**
1. Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see *Electrical Characteristics*. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
 2. The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} (maximum junction temperature), θ_{JA} (junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $\text{PD}_{\text{MAX}} = (T_{\text{JMAX}} - T_A) / \theta_{\text{JA}}$ or the number given in Absolute Maximum Ratings, whichever is lower. For the TCN4040 and TCN4041, $T_{\text{JMAX}} = 125^\circ\text{C}$, and the typical thermal resistance (θ_{JA}), when board mounted, is 185°C/W for the M package, 326°C/W for the SOT-23B-3 package, and 180°C/W with 0.4" lead length and 170°C/W with 0.125" lead length for the TO-92-3 package.
 3. The human body model is a 100 pF capacitor discharged through a 1.5 kW resistor into each pin. The machine model is a 200 pF capacitor discharged directly into each pin.

TCN4040-2.5 ELECTRICAL CHARACTERISTICS: Boldface type specifications apply for $T_A = T_J = T_{\text{MIN}}$ to T_{MAX} . All other specifications; $T_A = T_J = 25^\circ\text{C}$. The grades C, D, and E designate initial Reverse Breakdown Voltage tolerances of $\pm 0.5\%$, $\pm 1.0\%$, and $\pm 2.0\%$, respectively, unless otherwise specified.

Symbol	Parameter	Test Conditions	GRADE C			GRADE D			GRADE E			Unit
			Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_R	Reverse Breakdown Voltage	$I_R = 100 \mu\text{A}$ Notes 4, 5	—	2.500	—	—	2.500	—	—	2.500	—	V
	Reverse Breakdown Voltage Tolerance	$I_R = 100 \mu\text{A}$ Notes 4, 5, 6	—	—	± 12 ± 29	—	—	± 25 ± 49	—	—	± 50 ± 74	mV
$I_{R\text{MIN}}$	Minimum Operating Current	Notes 4, 5	—	45	60	—	45	65	—	45	65	μA
			—	—	65	—	—	70	—	—	70	
$\Delta V_R / \Delta T$	Average Reverse Breakdown Voltage Temperature Coefficient	$I_R = 10 \text{ mA}$ $I_R = 1 \text{ mA}$ $I_R = 100 \mu\text{A}$ Notes 4, 5	—	± 20	± 100	—	± 20	± 150	—	± 20	± 150	ppm/ $^\circ\text{C}$
			—	± 15	—	± 15	—	± 15	—	± 15	—	
			—	± 15	—	± 15	—	± 15	—	± 15	—	
$\Delta V_R / \Delta I_R$	Reverse Breakdown Voltage Change with Operating Current Change	$I_{R\text{MIN}} \leq I_R \leq 1 \text{ mA}$ Notes 4, 5	—	0.4	0.8	—	0.4	1.0	—	0.4	1.0	mV
			—	—	1.0	—	—	1.2	—	—	1.2	
		$1 \text{ mA} \leq I_R \leq 15 \text{ mA}$	—	2.5	6.0	—	2.5	8.0	—	2.5	8.0	mV
			—	—	8.0	—	—	10.0	—	—	10.0	

TCN4040-2.5 ELECTRICAL CHARACTERISTICS (Cont.) Boldface type specifications apply for $T_A = T_J = T_{MIN}$ to T_{MAX} . All other specifications; $T_A = T_J = 25^\circ\text{C}$. The grades C, D, and E designate initial Reverse Breakdown Voltage tolerances of $\pm 0.5\%$, $\pm 1.0\%$, and $\pm 2.0\%$, respectively, unless otherwise specified.

Symbol	Parameter	Test Conditions	GRADE C			GRADE D			GRADE E			Unit
			Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Z_R	Reverse Dynamic Impedance	$I_R = 1 \text{ mA}$, $f = 120 \text{ Hz}$, $I_{AC} = 0.1 I_R$ Notes 4, 5	—	0.3	0.9	—	0.3	1.1	—	0.3	1.1	Ω
e_N	Wideband Noise	$I_R = 100 \mu\text{A}$, $10 \text{ Hz} \leq f \leq 10 \text{ kHz}$ Notes 4, 5	—	35	—	—	35	—	—	35	—	μV_{RMS}
ΔV_R	Reverse Breakdown Voltage Long Term Stability	$t = 1000 \text{ hrs}$ $T = 25^\circ\text{C} \pm 0.1^\circ\text{C}$ $I_R = 100 \mu\text{A}$ Notes 4, 5	—	120	—	—	120	—	—	120	—	ppm/ $^\circ\text{C}$

- NOTES:**
- Typicals are at $T_J = 25^\circ\text{C}$ and represent most likely parametric norm.
 - Limits are 100% production tested at 25°C .
 - The boldface (over-temperature) limit for Reverse Breakdown Voltage Tolerance is defined as the room temperature Reverse Breakdown Voltage Tolerance $\pm[(\Delta V_R/\Delta T)(65^\circ\text{C})(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from -40°C to the reference point of 25°C , and V_R is the reverse breakdown voltage. The total over-temperature tolerance for the different grades are:
C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm}/^\circ\text{C} \times 65^\circ\text{C}$.
D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm}/^\circ\text{C} \times 65^\circ\text{C}$.
E-grade: $\pm 2.98\% = \pm 2.0\% \pm 150 \text{ ppm}/^\circ\text{C} \times 65^\circ\text{C}$.

TCN4041-1.2V ELECTRICAL CHARACTERISTICS: Boldface type specifications apply for $T_A = T_J = T_{MIN}$ to T_{MAX} . All other specifications; $T_A = T_J = 25^\circ\text{C}$. The grades C, D, and E designate initial Reverse Breakdown Voltage tolerances of $\pm 0.5\%$, $\pm 1.0\%$, and $\pm 2.0\%$, respectively, unless otherwise specified.

Symbol	Parameter	Test Conditions	GRADE C			GRADE D			GRADE E			Unit
			Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_R	Reverse Breakdown Voltage	$I_R = 100 \mu\text{A}$ Notes 4, 5	—	1.225	—	—	1.225	—	—	1.225	—	V
	Reverse Breakdown Voltage Tolerance	$I_R = 100 \mu\text{A}$ Notes 4, 5, 6	—		± 6 ± 14	—		± 12 ± 24	—		± 25 ± 36	mV
I_{RMIN}	Minimum Operating Current	Notes 4, 5	—	45	60 65	—	45	65 70	—	45	65 70	μA
$\Delta V_R/\Delta T$	Average Reverse Breakdown Voltage Temperature Coefficient	$I_R = 10 \text{ mA}$ $I_R = 1 \text{ mA}$ $I_R = 100 \mu\text{A}$ Notes 4, 5	—	± 20 ± 15 ± 15	± 100	—	± 20 ± 15 ± 15	± 150	—	± 20 ± 15 ± 15	± 150	ppm/ $^\circ\text{C}$
$\Delta V_R/\Delta I_R$	Reverse Breakdown Voltage Change with Operating Current Change	$I_{RMIN} \leq I_R \leq 1 \text{ mA}$ Notes 4, 5	—	0.7	1.5 2.0	—	0.7	2.0 2.5	—	0.7	2.0 2.5	mV
		$1 \text{ mA} \leq I_R \leq 12 \text{ mA}$	—	2.5	6.0 8.0	—	2.5	8.0 10.0	—	2.5	8.0 10.0	mV

TCN4040
TCN4041

TCN4041-1.2 ELECTRICAL CHARACTERISTICS (Cont.): Boldface type specifications apply for $T_A = T_J = T_{MIN}$ to T_{MAX} . All other specifications; $T_A = T_J = 25^\circ\text{C}$. The grades C, D, and E designate initial Reverse Breakdown Voltage tolerances of $\pm 0.5\%$, $\pm 1.0\%$, and $\pm 2.0\%$, respectively, unless otherwise specified.

Symbol	Parameter	Test Conditions	GRADE C			GRADE D			GRADE E			Unit
			Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Z_R	Reverse Dynamic Impedance	$I_R = 1 \text{ mA}$, $f = 120\text{Hz}$, $I_{AC} = 0.1 I_R$ Notes 4, 5	—	0.5	1.5	—	0.5	2.0	—	0.5	2.0	Ω
e_N	Wideband Noise	$I_R = 100 \mu\text{A}$, $10 \text{ Hz} \leq f \leq 10 \text{ kHz}$ Notes 4, 5	—	20	—	—	20	—	—	20	—	μVrms
ΔV_R	Reverse Breakdown Voltage Long Term Stability	$t = 1000 \text{ hrs}$ $T = 25^\circ\text{C} \pm 0.1^\circ\text{C}$ $I_R = 100 \mu\text{A}$ Notes 4, 5	—	120	—	—	120	—	—	120	—	$\text{ppm}/^\circ\text{C}$

- NOTES:**
- Typicals are at $T_J = 25^\circ\text{C}$ and represent most likely parametric norm.
 - Limits are 100% production tested at 25°C .
 - The boldface (over-temperature) limit for Reverse Breakdown Voltage Tolerance is defined as the room temperature Reverse Breakdown Voltage Tolerance $\pm[(\Delta V_R/\Delta T)(65^\circ\text{C})(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from -40°C to the reference point of 25°C , and V_R is the reverse breakdown voltage. The total over-temperature tolerance for the different grades are:
C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm}/^\circ\text{C} \times 65^\circ\text{C}$.
D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm}/^\circ\text{C} \times 65^\circ\text{C}$.
E-grade: $\pm 2.98\% = \pm 2.0\% \pm 150 \text{ ppm}/^\circ\text{C} \times 65^\circ\text{C}$.

TCN4041-ADJ ELECTRICAL CHARACTERISTICS: Boldface type specifications apply for $T_A = T_J = T_{MIN}$ to T_{MAX} . All other specifications; $T_A = T_J = 25^\circ\text{C}$, unless otherwise specified (SOT-23B-3, see Note 7), $I_{RMIN} \leq I_R \leq 12 \text{ mA}$, $V_{REF} \leq V_{OUT} \leq 0\text{V}$. The grades C and D designate initial Reverse Breakdown Voltage tolerances of $\pm 0.5\%$ and $\pm 1.0\%$, respectively, unless otherwise specified.

Symbol	Parameter	Test Conditions	GRADE C			GRADE D			Unit
			Min	Typ	Max	Min	Typ	Max	
V_R	Reverse Breakdown Voltage	$I_R = 100 \mu\text{A}$, $V_{OUT} = 5\text{V}$ Notes 4, 5	—	1.233	—	—	1.233	—	V
	Reverse Breakdown Voltage Tolerance	$I_R = 100 \mu\text{A}$, $V_{OUT} = 5\text{V}$ Notes 4, 5, 8	—	—	± 6.2 ± 14	—	—	± 12 ± 24	mV
I_{RMIN}	Minimum Operating Current	Notes 4, 5	—	45	60 65	—	45	65 70	μA
$\Delta V_{REF}/\Delta I_R$	Reference Voltage Change with Operating Current Change	$I_{RMIN} \leq I_R \leq 1 \text{ mA}$ SOT-23B: $V_{OUT} \geq 1.6\text{V}$ Notes 4, 5, 7	—	0.7	1.5 2.0	—	0.7	2.0 2.5	mV
		$I_{RMIN} \leq I_R \leq 12 \text{ mA}$ SOT-23B: $V_{OUT} \geq 1.6\text{V}$ Notes 4, 5, 7	—	2	4 6	—	2	6 8	mV
$\Delta V_{REF}/\Delta V_{OUT}$	Reverse Voltage Change with Output Voltage Change	$I_R = 1 \text{ mA}$ Notes 4, 5	—	-1.3	-2.0 -2.5	—	-1.3	-2.5 -3.0	mV/V

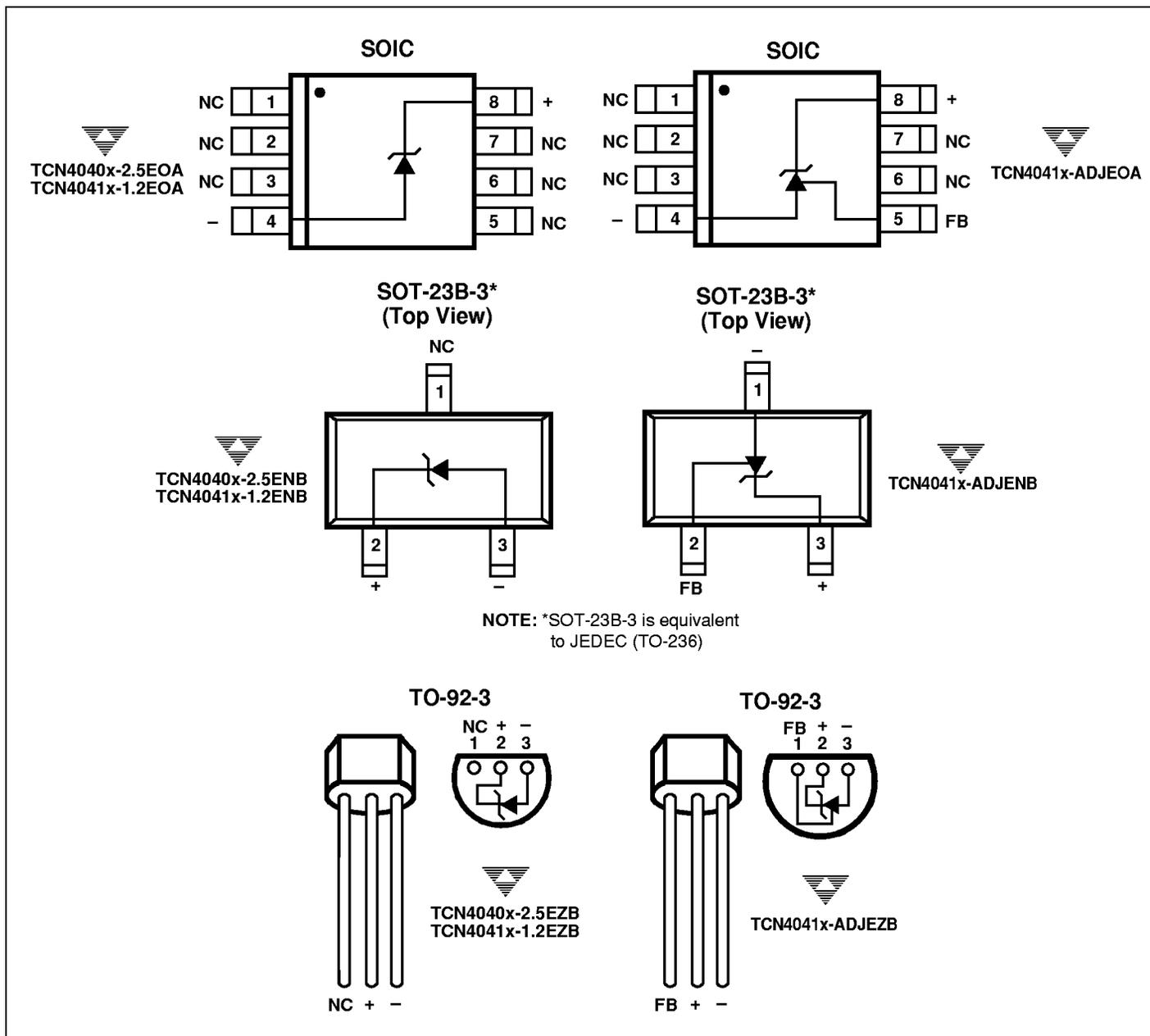
TCN4041-ADJ ELECTRICAL CHARACTERISTICS (Cont.): Boldface type specifications apply for $T_A = T_J = T_{MIN}$ to T_{MAX} . All other specifications; $T_A = T_J = 25^\circ\text{C}$, unless otherwise specified (SOT-23B-3, see Note 7), $I_{RMIN} \leq I_R \leq 12 \text{ mA}$, $V_{REF} \leq V_{OUT} \leq 10\text{V}$. The grades C and D designate initial Reverse Breakdown Voltage tolerances of $\pm 0.5\%$ and $\pm 1.0\%$, respectively, unless otherwise specified.

Symbol	Parameter	Test Conditions	GRADE C			GRADE D			Unit
			Min	Typ	Max	Min	Typ	Max	
I_{FB}	Feedback Current	Notes 4, 5	—	60	100 120	—	60	150 200	nA
$\Delta V_R/\Delta T$	Average Reverse Breakdown Voltage Temperature Coefficient	$V_{OUT} = 5\text{V}$, $I_R = 10 \text{ mA}$ $I_R = 1 \text{ mA}$ $I_R = 100 \mu\text{A}$ Notes 4, 5	—	± 20 ± 15 ± 15	± 100	—	± 20 ± 15 ± 15	± 150	ppm/ $^\circ\text{C}$
Z_{OUT}	Dynamic Output Impedance	$I_R = 1 \text{ mA}$, $f = 120 \text{ Hz}$, $I_{AC} = 0.1 I_R$, $V_{OUT} = V_{REF}$ $V_{OUT} = 10\text{V}$ Notes, 4, 5	—	0.3 2	—	—	0.3 2	—	Ω
e_N	Wideband Noise	$I_R = 100 \mu\text{A}$, $V_{OUT} = V_{REF}$ $10 \text{ Hz} \leq f \leq 10 \text{ kHz}$ Notes 4, 5	—	20	—	—	20	—	μV_{RMS}
ΔV_R	Reverse Voltage Long Term Stability	$t = 1000 \text{ hrs}$ $T = 25^\circ\text{C} \pm 0.1^\circ\text{C}$ $I_R = 100 \mu\text{A}$ Notes 4, 5	—	120	—	—	120	—	ppm/ $^\circ\text{C}$

- NOTES:**
- Typicals are at $T_J = 25^\circ\text{C}$ and represent most likely parametric norm.
 - Limits are 100% production tested at 25°C .
 - The boldface (over-temperature) limit for Reverse Breakdown Voltage Tolerance is defined as the room temperature Reverse Breakdown Voltage Tolerance $\pm[(\Delta V_R/\Delta T)(65^\circ\text{C})(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from -40°C to the reference point of 25°C , and V_R is the reverse breakdown voltage. The total over-temperature tolerance for the different grades are:
C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm}/^\circ\text{C} \times 65^\circ\text{C}$
D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm}/^\circ\text{C} \times 65^\circ\text{C}$
E-grade: $\pm 2.98\% = \pm 2.0\% \pm 150 \text{ ppm}/^\circ\text{C} \times 65^\circ\text{C}$
 - When $V_{OUT} \leq 1.6\text{V}$, the TCN4041-ADJ in the SOT-23B-3 package must operate at reduced I_R . This is caused by the series resistance of the die attach between the die (-) output and the package (-) output pin. See the Output Saturation (SOT-23-B only) curve in the *Typical Characteristics* section.
 - Reference voltage and temperature coefficient will change with output voltage. See *Typical Characteristics* curves.

TCN4040
TCN4041

PIN CONFIGURATIONS



PIN DESCRIPTION

Pin No. 8-Pin SOIC 1.2V & 2.5V	Pin No. 8-Pin SOIC ADJ	Pin No. SOT-23B-3 1.2V & 2.5V	Pin No. SOT-23B-3 ADJ	Pin No. TO-92-3 1.2V & 2.5V	Pin No. TO-92-3 ADJ	Symbol	Description
1, 2, 3, 5, 6, 7	1, 2, 3, 6, 7	1		1		NC	No connection
4	4	3	1	3	3	-	Negative terminal
8	8	2	3	2	2	+	Positive terminal
	5		2		1	FB	Feedback current

APPLICATIONS INFORMATION

Available in space-saving SOT-23B-3 surface mount packages, the TCN4040/41 are precision micro-power bandgap shunt voltage references. They are designed for stable operation without an external capacitor connected between the “+” pin and the “-” pin. The TCN4040/4041 also remain stable, however, if a bypass capacitor is used. The devices are available in either a fixed 1.2V or an adjustable reverse breakdown voltage (TCN4041); or a fixed voltage of 2.5V (TCN4040). The minimum operating current is 60 μA, and the maximum operating current is 12 mA for both TCN4041 options and 15 mA for the TCN4040.

TCN4040/4041s in the SOT-23B-3 package have pin 1 connected as the “-” terminal of a parasitic Schottky diode. (Die attach interface contact). Therefore, pin 1 of the TCN4041-1.2 and TCN4040 must be left floating or connected to pin 3, and pin 1 on the TCN4041-ADJ is the (-) output.

In a conventional shunt regulator application, an external series resistor (R_S) is connected between the supply voltage and the TCN4040/4041 (Figure 1). R_S determines the current that flows through the load (I_L) and the TCN4040/4041 (I_Q). Even when the supply voltage is at its minimum, and the load current is at its maximum value, R_S should be small enough to supply at least the minimum acceptable I_Q to the TCN4040/4041 since load current and supply voltage may vary. Conversely, when the supply voltage is at its maximum and I_L is at its minimum, R_S should be large enough that the current flowing through the TCN4041 is less than 12 mA, and current flowing through the TCN4040 is less than 15 mA.

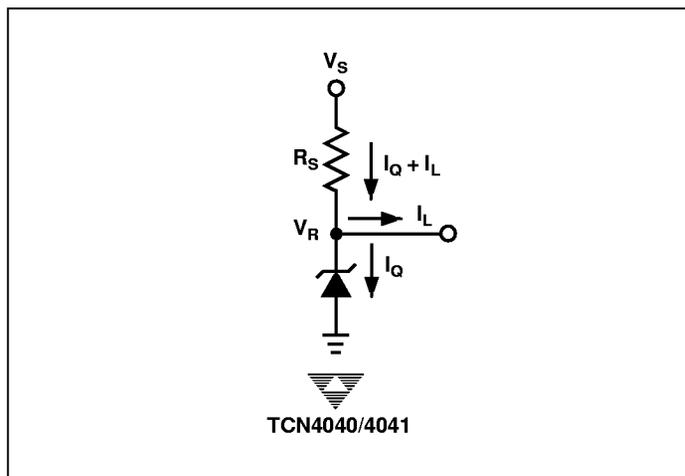


Figure 1. Shunt Regulator

R_S is determined by the supply voltage, (V_S), the load and operating current, (I_L and I_Q), and the TCN4040/4041's reverse breakdown voltage, V_R .

$$R_S = \frac{V_S - V_R}{I_L + I_Q}$$

Output voltage on the TCN4041-ADJ can be adjusted to any value between 1.24V and 10V. It is a function of the internal reference voltage (V_{REF}) and the ratio of the external feedback resistors (see Figure 2). The output can be found with the equation (where V_{OUT} is the desired output voltage):

$$V_{OUT} = V_{REF} (R_2/R_1 + 1)$$

Equation 1.

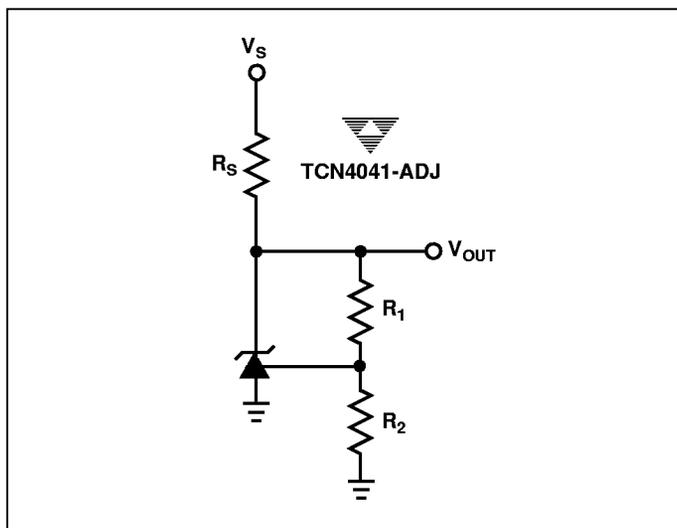


Figure 2. Adjustable Shunt

The value of the internal V_{REF} is a function of V_{OUT} . The “corrected” V_{REF} can be determined by (where V_{OUT} is the desired output voltage):

$$V_{REF} = V_{OUT} (\Delta V_{REF}/\Delta V_{OUT}) + V_Y$$

Equation 2.

$\Delta V_{REF}/\Delta V_{OUT}$ is typically -1.3 mV/V , and $V_Y = 1.240V$. Replace the value of V_{REF} in Equation 1 with the value determined using Equation 2.

The actual output voltage can deviate from that predicted by the typical $\Delta V_{REF}/\Delta V_{OUT}$ in Equation 2. The worst case $\Delta V_{REF}/\Delta V_{OUT}$ for C-grade parts is -2.5 mV/V and $V_Y = 1.246V$; for D-grade, the worst case is -3.0 mV/V and $V_Y = 1.248V$.

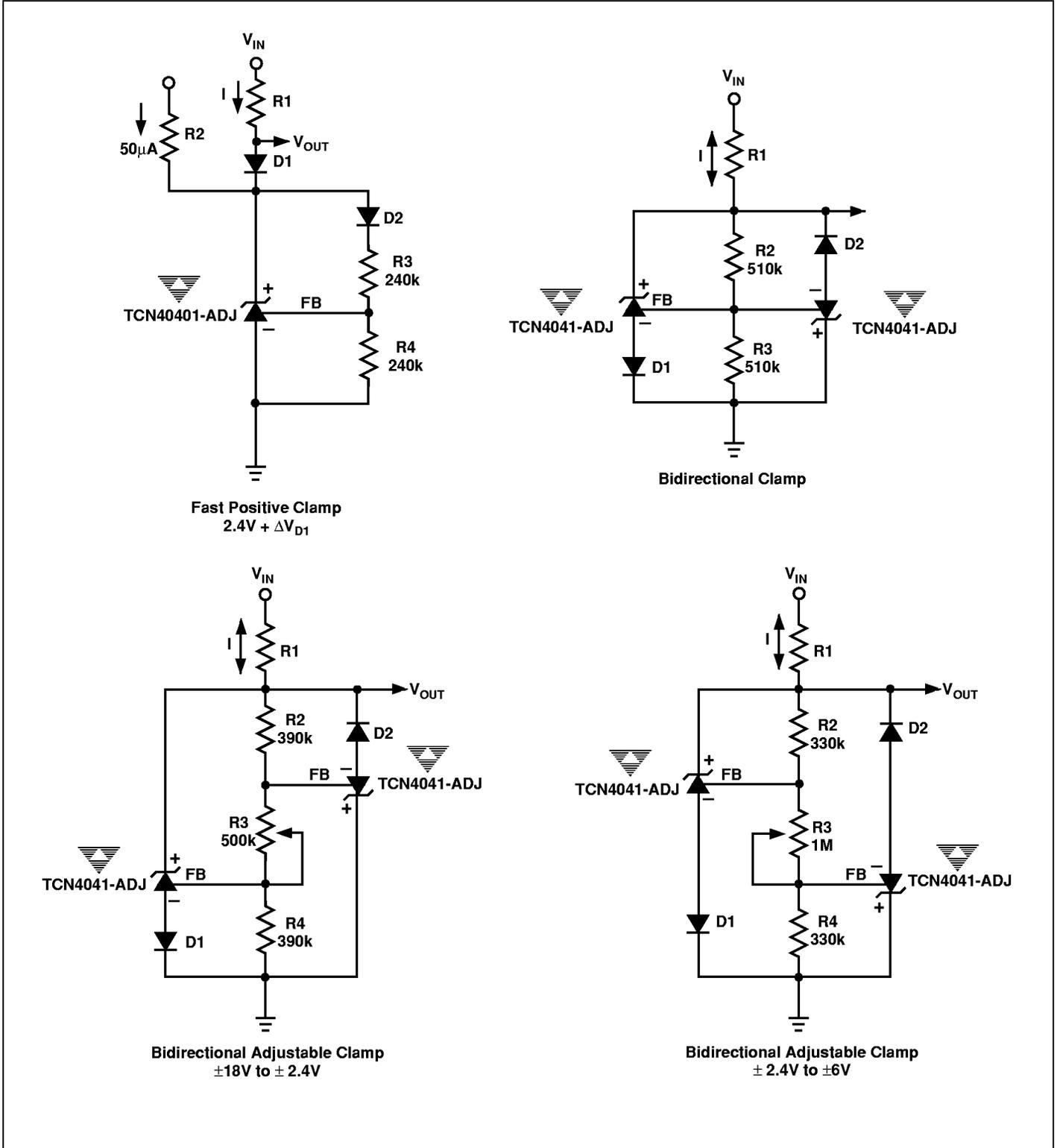
The difference in output voltage resulting from typical worst case values are shown in the following example: Let $V_{OUT} = +9V$. Using the typical value of $\Delta V_{REF}/\Delta V_{OUT}$, V_{REF} is 1.228; choosing a value of $R_1 = 10 \text{ k}\Omega$, $R_2 = 63.272 \text{ k}\Omega$.

TCN4040
TCN4041

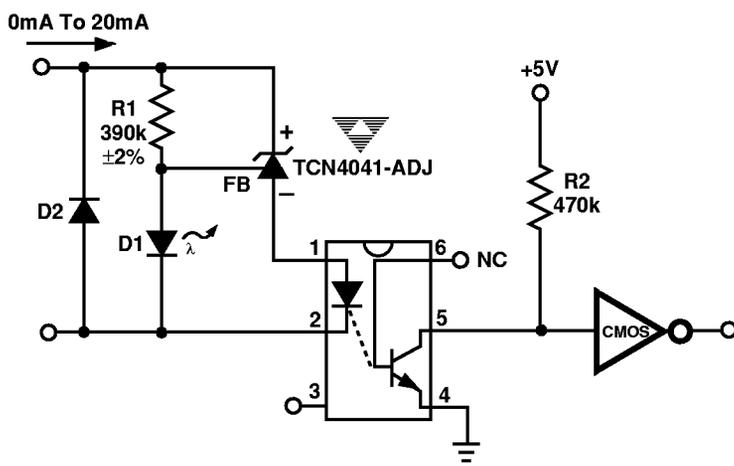
The output voltage, when using worst case $\Delta V_{REF}/\Delta V_{OUT}$ for C-grade and D-grade parts, is 8.965V and 8.946V, respectively. This could result in errors as large as 0.39% for

C-grade, and 0.59% for D-grade parts. However, resistor values resulting from the typical value of $\Delta V_{REF}/\Delta V_{OUT}$ will work most of the time, requiring no additional adjustments.

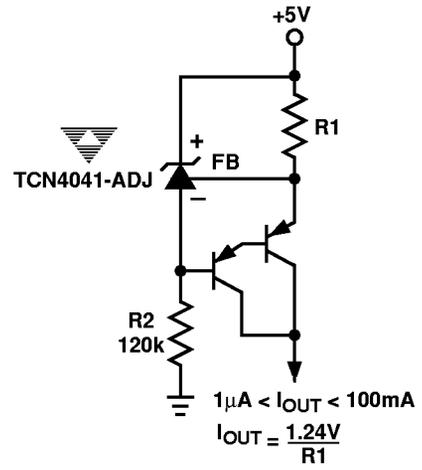
TYPICAL APPLICATIONS



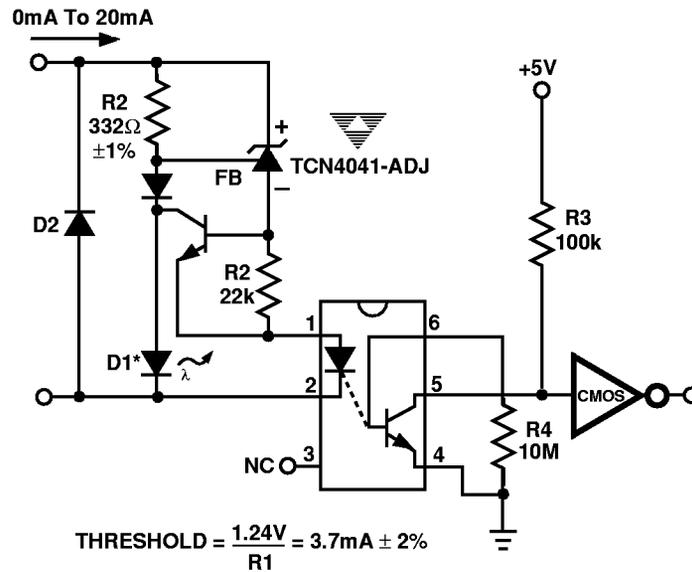
TYPICAL APPLICATIONS (Cont.)



Simple Floating Current Detector



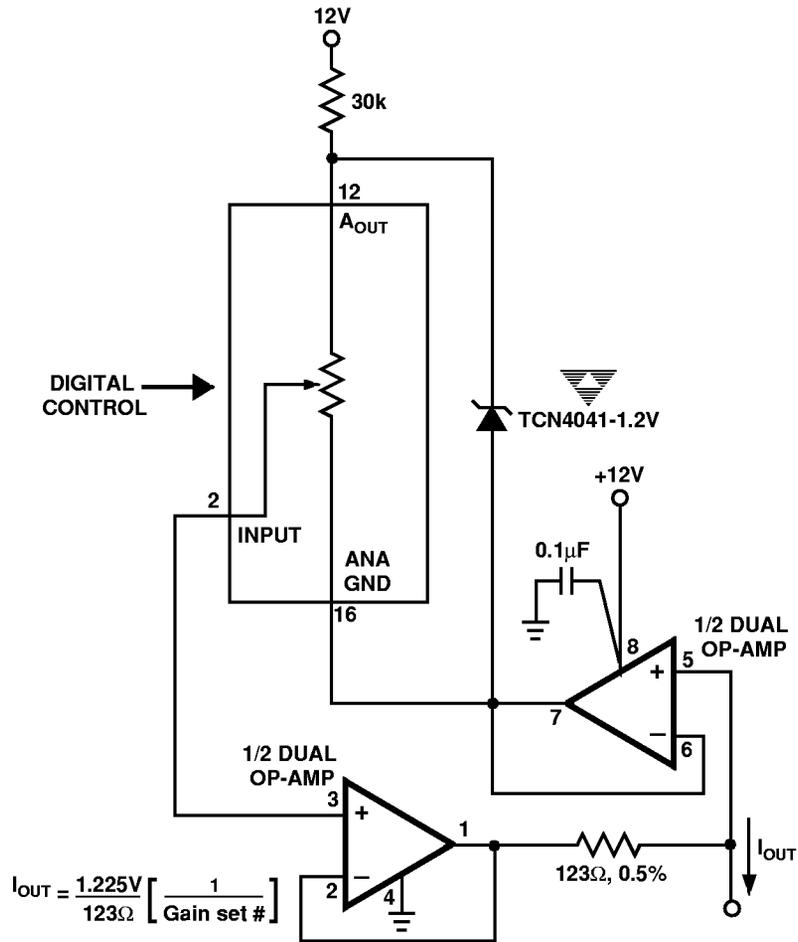
Current Source



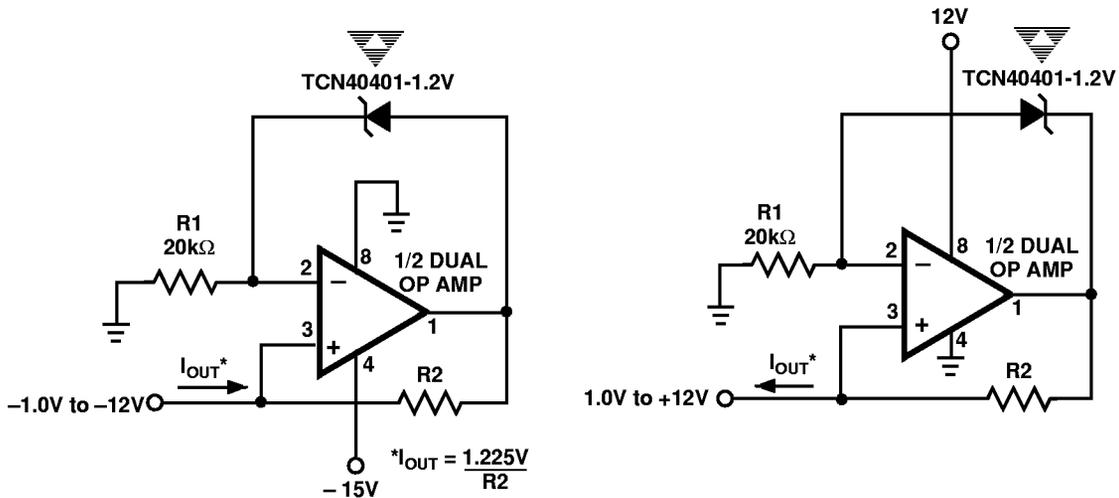
Precision Floating Current Detector

TCN4040
TCN4041

TYPICAL APPLICATIONS (Cont.)



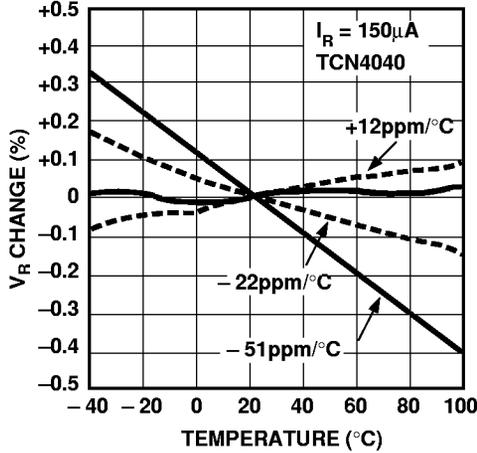
Programmable Current Source



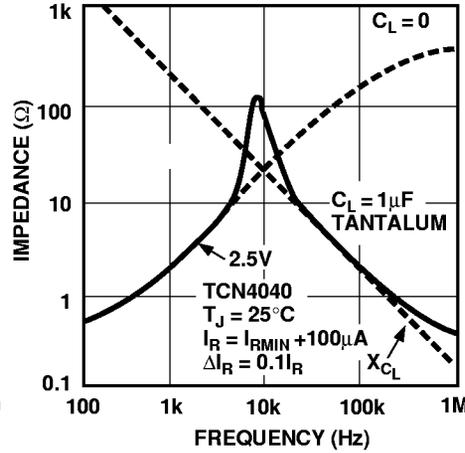
Precision 1μA to 1mA Current Sources

TYPICAL CHARACTERISTICS

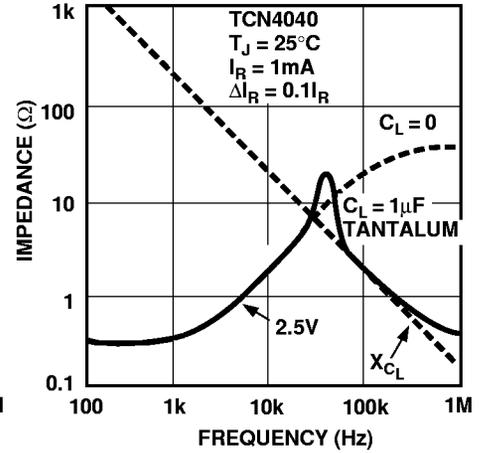
Temperature Drift for Different Average Temperature Coefficient



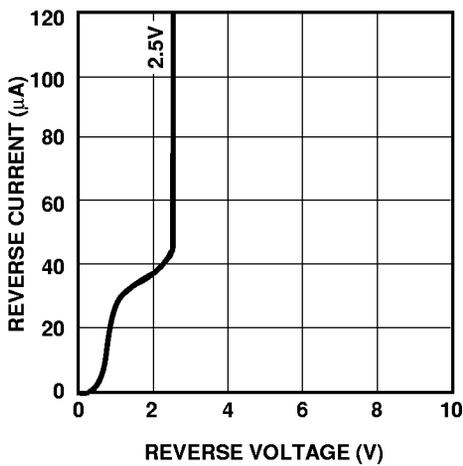
Output Impedance vs. Frequency



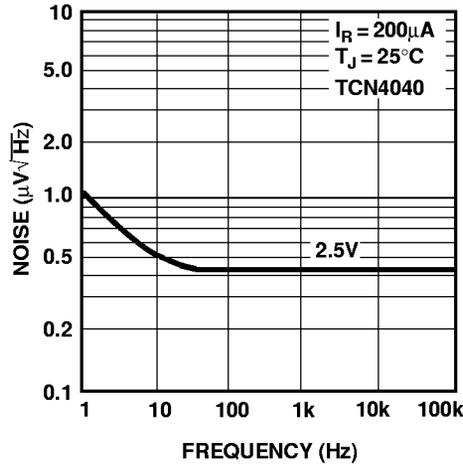
Output Impedance vs. Frequency



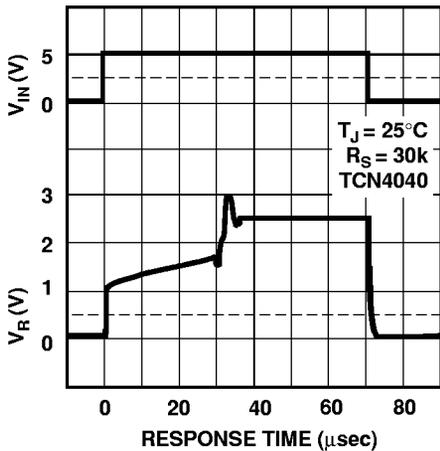
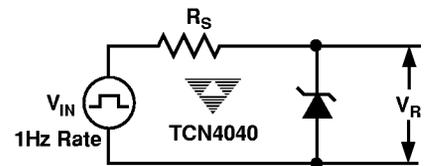
Reverse Characteristics and Minimum Operating Current



Noise Voltage vs. Frequency



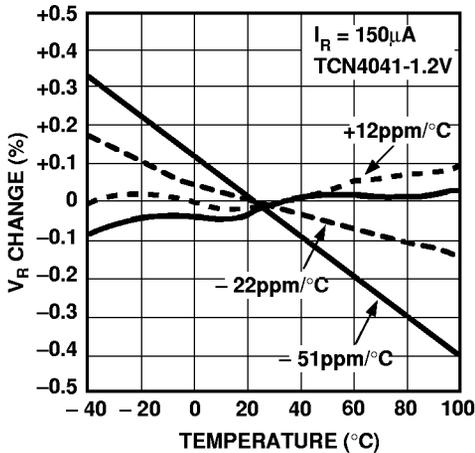
Test Circuit



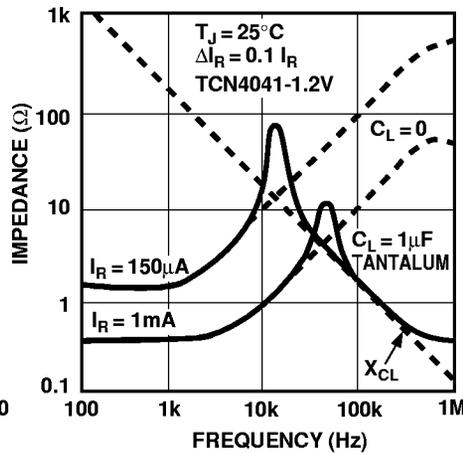
TCN4040
TCN4041

TYPICAL CHARACTERISTICS

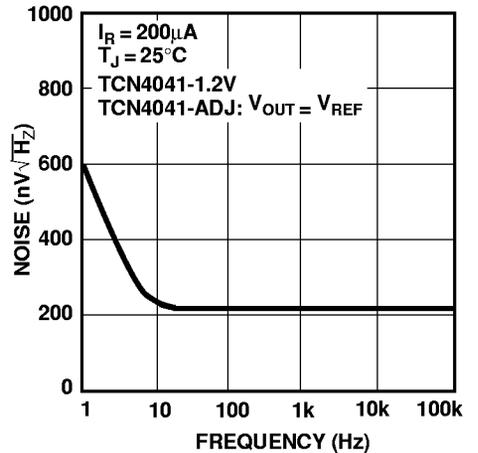
Temperature Drift for Different Average Temperature Coefficient



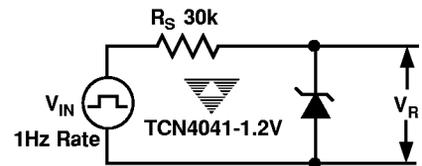
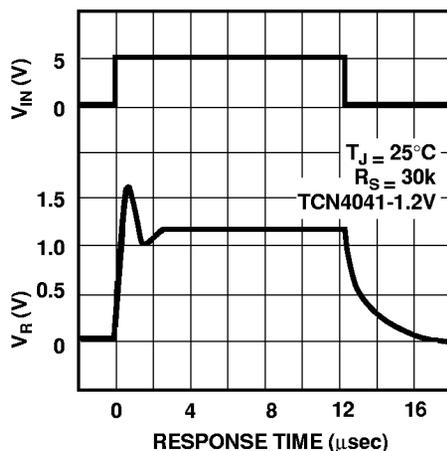
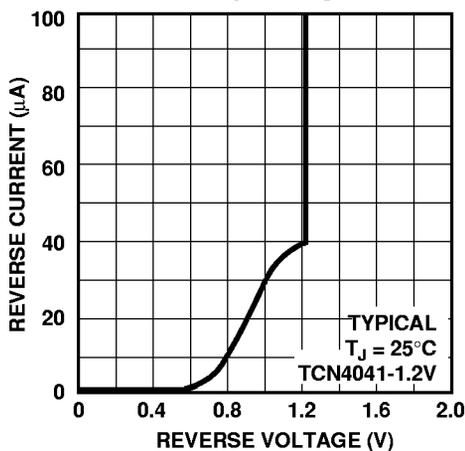
Output Impedance vs. Frequency



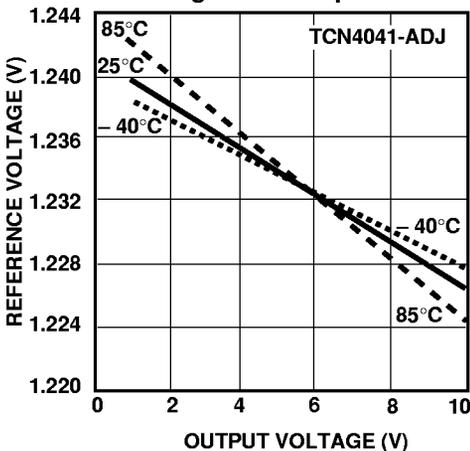
Noise Voltage



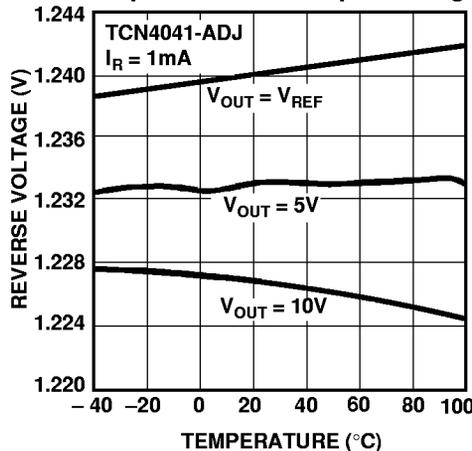
Reverse Characteristics and Minimum Operating Current



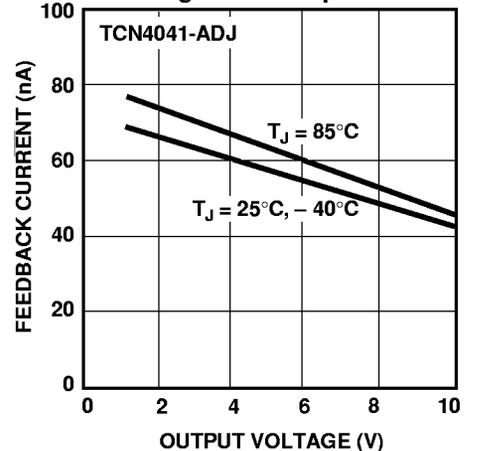
Reference Voltage vs. Output Voltage and Temperature



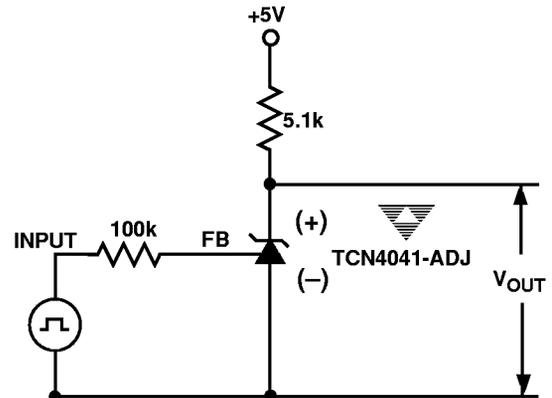
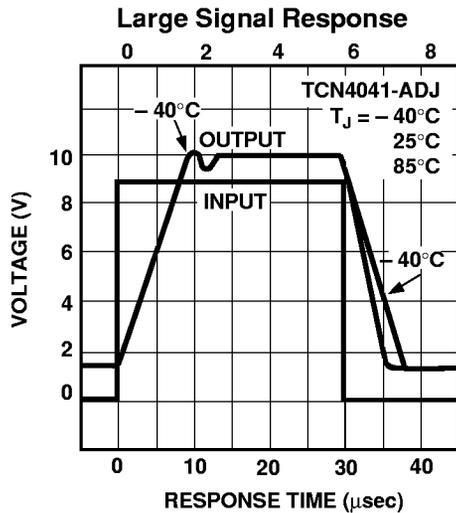
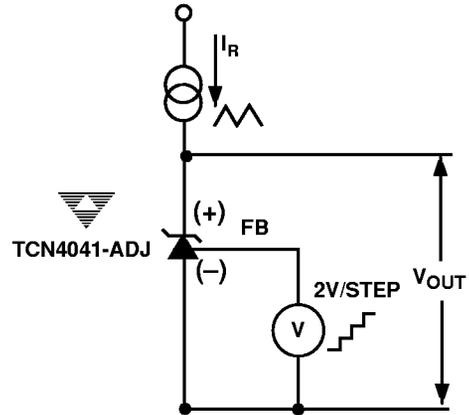
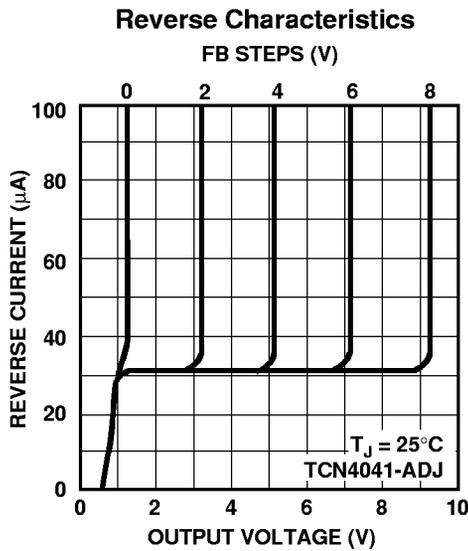
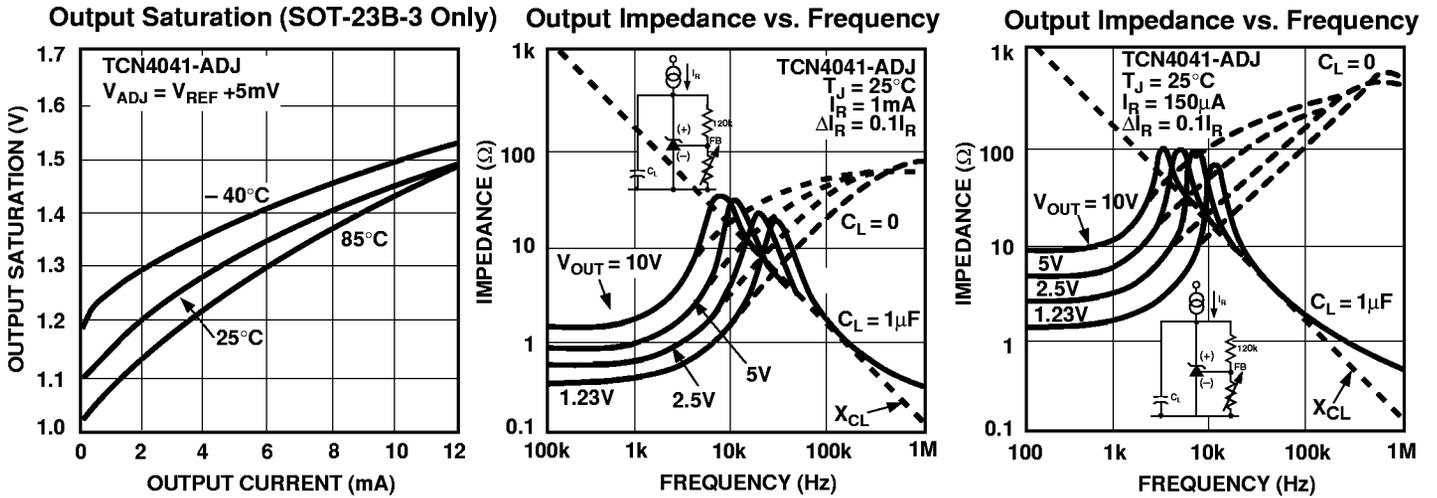
Reference Voltage vs. Temperature and Output Voltage



Feedback Current vs. Output Voltage and Temperature



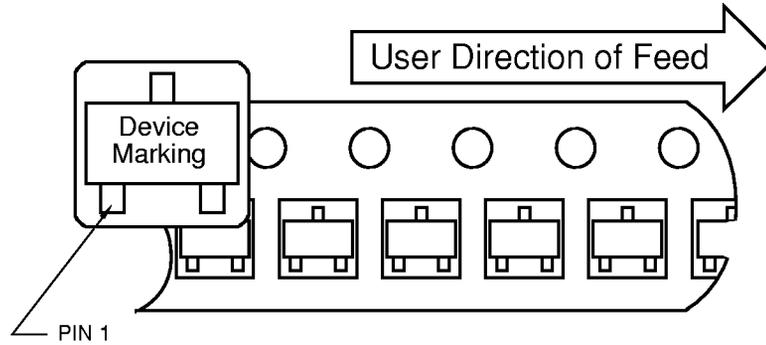
TYPICAL CHARACTERISTICS (CONT.)



**TCN4040
TCN4041**

TAPING FORM

Component Taping Orientation for 3L SOT-23B (JEDEC -236) Devices

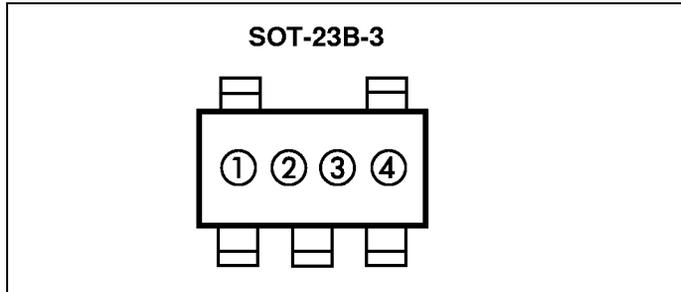


Standard Reel Component Orientation
for 713 or TR Suffix Device
(Mark Right Side Up)

Tape and Reel Specifications Table

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
3L SOT-23B	8 mm	4 mm	3000	7

MARKING



Only three fields of marking are possible on the SOT-23B-3's small surface. The meanings of the three fields are as follows:

First field (fixed):

TBD

Second Field:

TBD

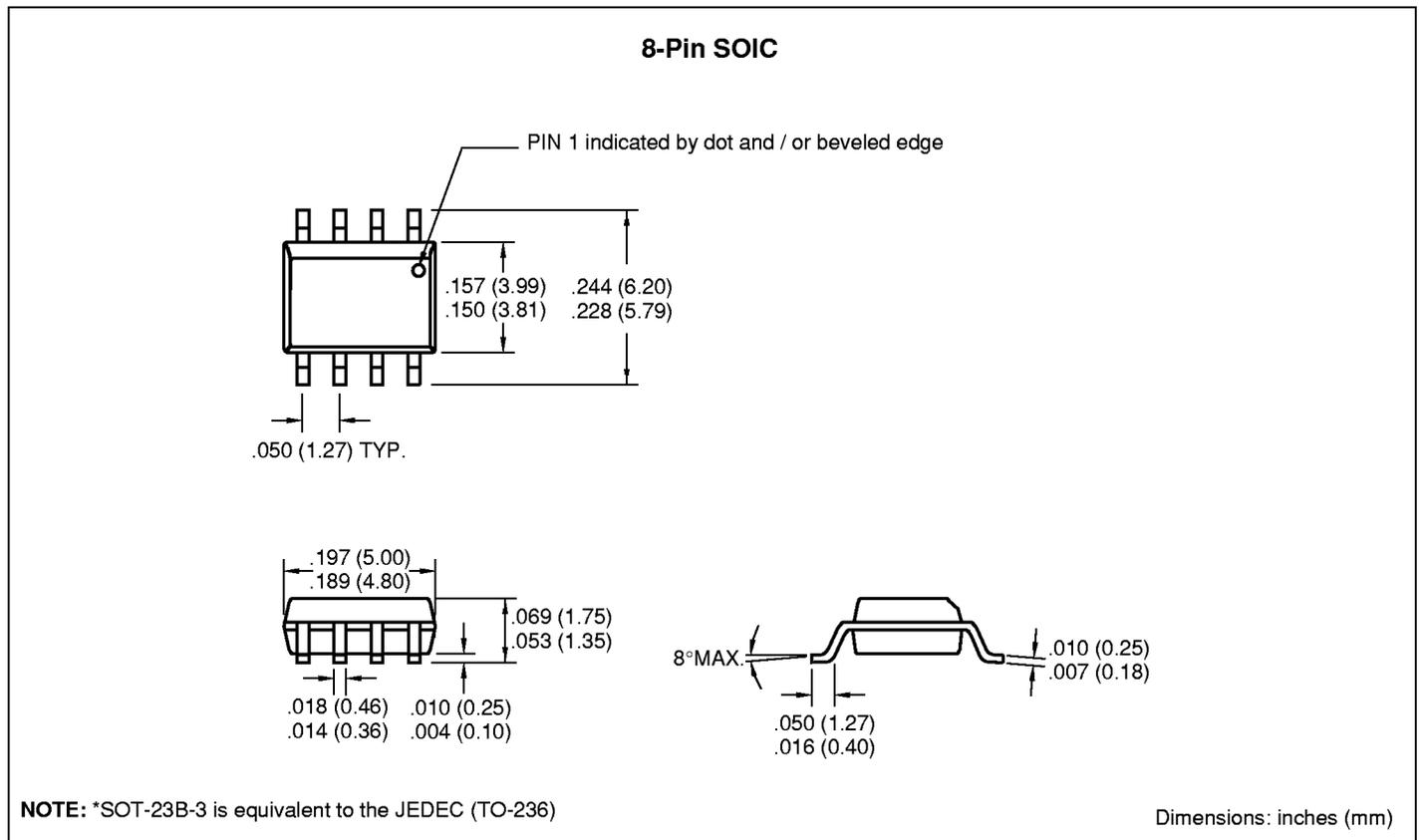
Third Field:

TBD

Example: Package marking "TBD" indicates...

TCN4041 (V)	Code
1.2	H1
ADJ	H2

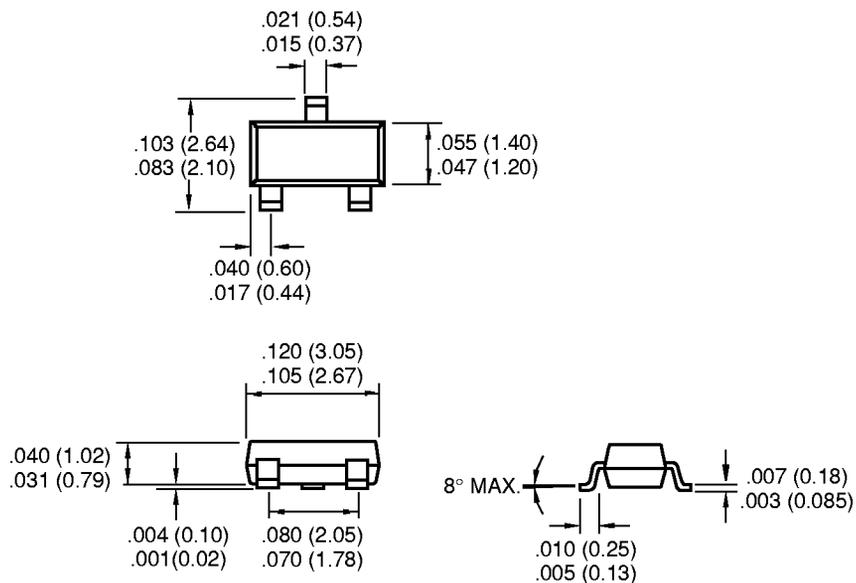
PACKAGE DIMENSIONS



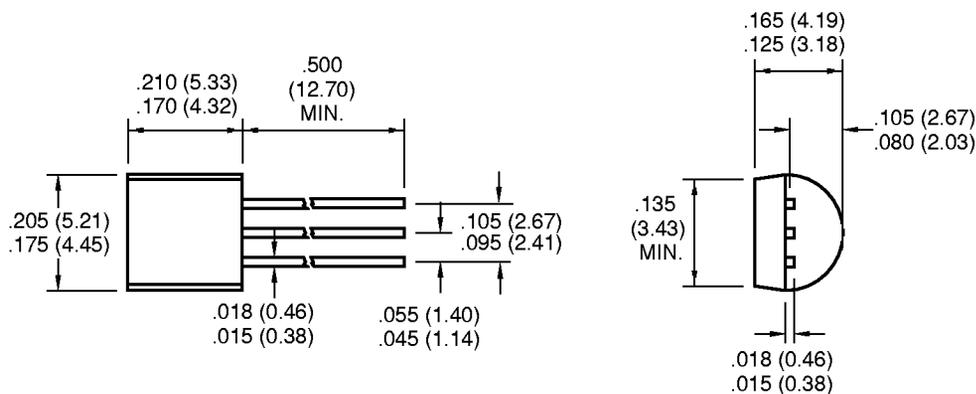
TCN4040
TCN4041

PACKAGE DIMENSIONS (CONT.)

SOT-23B-3*



TO-92-3



Dimensions: inches (mm)

Sales Offices

TelCom Semiconductor
1300 Terra Bella Avenue
P.O. Box 7267
Mountain View, CA 94039-7267
TEL: 650-968-9241
FAX: 650-967-1590
E-Mail: liter@c2smtp.telcom-semi.com

TelCom Semiconductor
Austin Product Center
9101 Burnet Rd. Suite 214
Austin, TX 78758
TEL: 512-873-7100
FAX: 512-873-8236

TelCom Semiconductor H.K. Ltd.
10 Sam Chuk Street, 6/F
San Po Kong
Kowloon
Hong Kong
TEL: 852-2324-0122
FAX: 852-2354-9957